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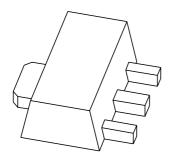
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Team Nexperia

### **DISCRETE SEMICONDUCTORS**

# DATA SHEET



PBSS5350X 50 V, 3 A PNP low V<sub>CEsat</sub> (BISS) transistor

Product data sheet Supersedes data of 2003 Nov 21 2004 Nov 04



# 50 V, 3 A PNP low V<sub>CEsat</sub> (BISS) transistor

### **PBSS5350X**

#### **FEATURES**

- SOT89 (SC-62) package
- Low collector-emitter saturation voltage V<sub>CEsat</sub>
- $\bullet$  High collector current capability:  $I_{C}$  and  $I_{CM}$
- · Higher efficiency leading to less heat generation
- Reduced printed-circuit board requirements.

#### **APPLICATIONS**

- Power management
  - DC/DC converters
  - Supply line switching
  - Battery charger
  - LCD backlighting.
- · Peripheral drivers
  - Driver in low supply voltage applications (e.g. lamps and LEDs).
  - Inductive load driver (e.g. relays, buzzers and motors).

#### **DESCRIPTION**

PNP low  $V_{CEsat}$  transistor in a SOT89 plastic package. NPN complement: PBSS4350X.

#### MARKING

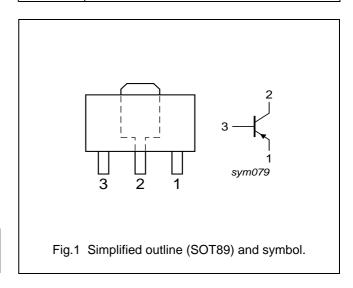
TYPE NUMBER	MARKING CODE
PBSS5350X	S46

#### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	MAX.	UNIT
V <sub>CEO</sub>	collector-emitter voltage	-50	V
I <sub>C</sub>	collector current (DC)	-3	Α
I <sub>CM</sub>	peak collector current	-5	Α
R <sub>CEsat</sub>	equivalent on-resistance	135	mΩ

#### **PINNING**

PIN	DESCRIPTION
1	emitter
2	collector
3	base



# 50 V, 3 A PNP low $V_{CEsat}$ (BISS) transistor

PBSS5350X

#### **ORDERING INFORMATION**

TYPE NUMBER PACKAGE		PACKAGE		
TIPE NOWIDER	NAME	DESCRIPTION VER		
PBSS5350X	SC-62 plastic surface mounted package; collector pad for good heat transfer; 3 leads		SOT89	

#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

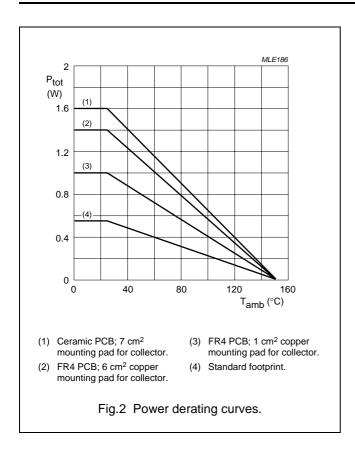
SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	_	-50	V
V <sub>CEO</sub>	collector-emitter voltage	open base	_	-50	V
V <sub>EBO</sub>	emitter-base voltage	open collector	_	-5	V
I <sub>C</sub>	collector current (DC)	note 4	_	-3	Α
I <sub>CM</sub>	peak collector current	limited by T <sub>j(max)</sub>	_	-5	Α
I <sub>B</sub>	base current (DC)		_	-0.5	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C			
		note 1	_	550	mW
		note 2	_	1	W
		note 3	_	1.4	W
		note 4	_	1.6	W
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C

#### Notes

- 1. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; standard footprint.
- 2. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.
- 3. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 6 cm<sup>2</sup>.
- 4. Device mounted on a ceramic printed-circuit board 7 cm<sup>2</sup>, single-sided copper, tin-plated.

# 50 V, 3 A PNP low $V_{CEsat}$ (BISS) transistor

PBSS5350X



# 50 V, 3 A PNP low $V_{CEsat}$ (BISS) transistor

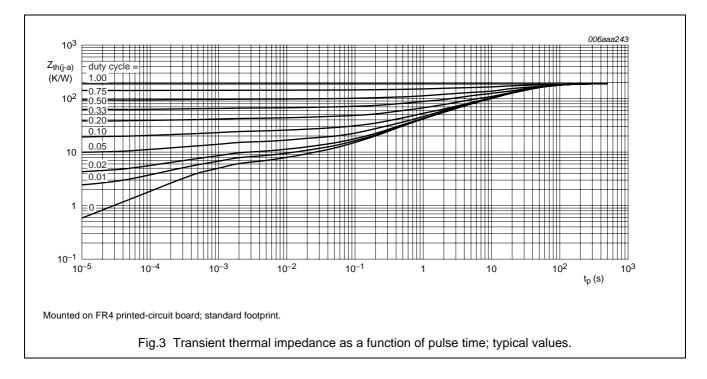
PBSS5350X

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air		
		note 1	225	K/W
		note 2	125	K/W
		note 3	90	K/W
		note 4	80	K/W
R <sub>th(j-s)</sub>	thermal resistance from junction to soldering point		16	K/W

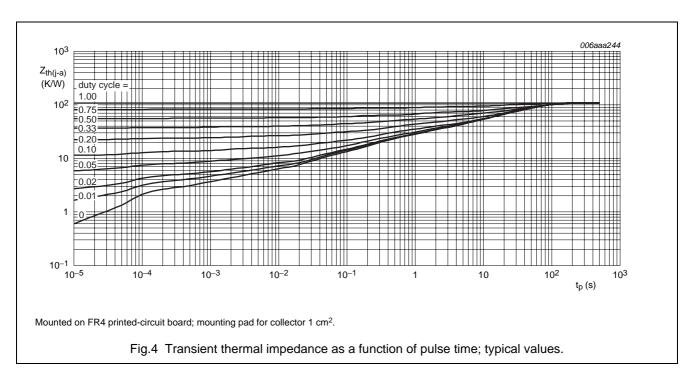
#### **Notes**

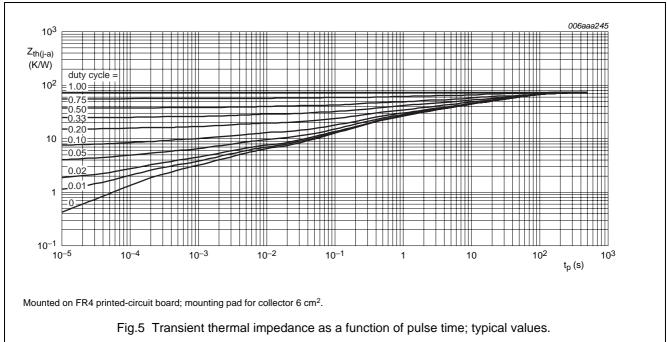
- 1. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; standard footprint.
- 2. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.
- 3. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 6 cm<sup>2</sup>.
- 4. Device mounted on a ceramic printed-circuit board 7 cm<sup>2</sup>, single-sided copper, tin-plated.



50 V, 3 A PNP low  $V_{CEsat}$  (BISS) transistor

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# 50 V, 3 A PNP low $V_{\text{CEsat}}$ (BISS) transistor

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#### **CHARACTERISTICS**

 $T_{amb}$  = 25  $^{\circ}C$  unless otherwise specified.

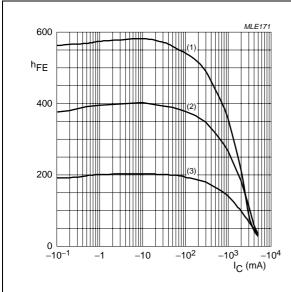
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = -50 \text{ V}; I_E = 0 \text{ A}$	_	_	-100	nA
		$V_{CB} = -50 \text{ V}; I_E = 0 \text{ A}; T_j = 150 ^{\circ}\text{C}$	_	_	-50	μΑ
I <sub>CES</sub>	collector-emitter cut-off current	$V_{CE} = -50 \text{ V}; V_{BE} = 0 \text{ V}$	_	_	-100	nA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0 \text{ A}$	_	_	-100	nA
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = −2 V				
		$I_{C} = -0.1 \text{ A}$	200	_	_	
		$I_{C} = -0.5 \text{ A}$	200	_	_	
		$I_C = -1 A$ ; note 1	200	_	450	
		$I_{C} = -2 \text{ A}$ ; note 1	130	_	_	
		$I_{C} = -3 \text{ A}$ ; note 1	80	_	_	
V <sub>CEsat</sub>	collector-emitter saturation	$I_C = -0.5 \text{ A}; I_B = -50 \text{ mA}$	_	_	-90	mV
	voltage	$I_C = -1 \text{ A}; I_B = -50 \text{ mA}$	_	_	-180	mV
		$I_C = -2 \text{ A}; I_B = -100 \text{ mA}$	_	_	-320	mV
		$I_C = -2 \text{ A}$ ; $I_B = -200 \text{ mA}$ ; note 1	_	_	-270	mV
		$I_C = -3 \text{ A}$ ; $I_B = -300 \text{ mA}$ ; note 1	_	_	-390	mV
R <sub>CEsat</sub>	equivalent on-resistance	$I_C = -2 \text{ A}$ ; $I_B = -200 \text{ mA}$ ; note 1	_	90	135	mΩ
V <sub>BEsat</sub>	base-emitter saturation voltage	$I_C = -2 \text{ A}; I_B = -100 \text{ mA}$	_	_	-1.1	V
		$I_C = -3 \text{ A}$ ; $I_B = -300 \text{ mA}$ ; note 1	_	_	-1.2	V
$V_{BEon}$	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; I_{C} = -1 \text{ A}$	-1.1	_	_	V
f <sub>T</sub>	transition frequency	$I_C = -100 \text{ mA}; V_{CE} = -5 \text{ V};$ f = 100 MHz	100	_	_	MHz
C <sub>c</sub>	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = i_e = 0 \text{ A}; f = 1 \text{ MHz}$	_	_	35	pF

#### Note

1. Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 

### 50 V, 3 A PNP low V<sub>CEsat</sub> (BISS) transistor

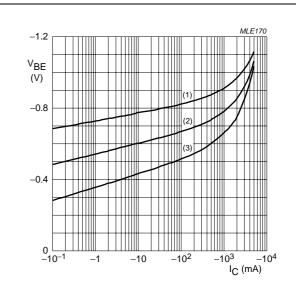
### PBSS5350X



 $V_{CE} = -2 V$ .

- (1)  $T_{amb} = 100 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

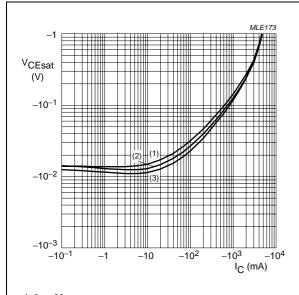
Fig.6 DC current gain as a function of collector current; typical values.



 $V_{CE} = -2 V$ .

- (1)  $T_{amb} = -55 \,^{\circ}\text{C}$ . (2)  $T_{amb} = 25 \,^{\circ}\text{C}$ .
- (3)  $T_{amb} = 100 \, ^{\circ}C$ .

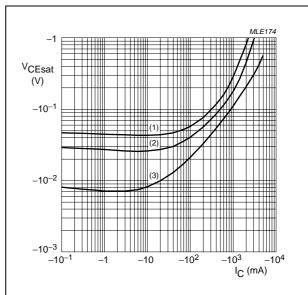
Fig.7 Base-emitter voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 20.$ 

- (1)  $T_{amb} = 100 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

Fig.8 Collector-emitter saturation voltage as a function of collector current; typical values.



 $T_{amb} = 25 \, ^{\circ}C.$ 

- (1)  $I_C/I_B = 100$
- (2)  $I_C/I_B = 50$ .
- (3)  $I_C/I_B = 10$ .

Fig.9 Collector-emitter saturation voltage as a function of collector current; typical values.

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# 50 V, 3 A PNP low $V_{CEsat}$ (BISS) transistor

### PBSS5350X

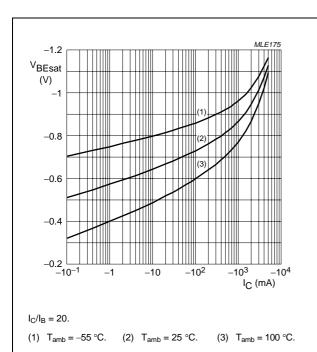


Fig.10 Base-emitter saturation voltage as a function of collector current; typical values.

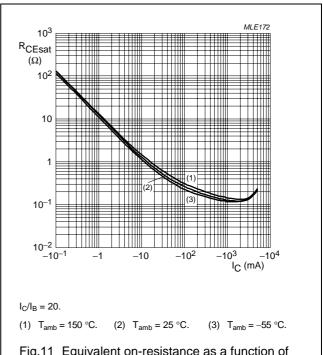
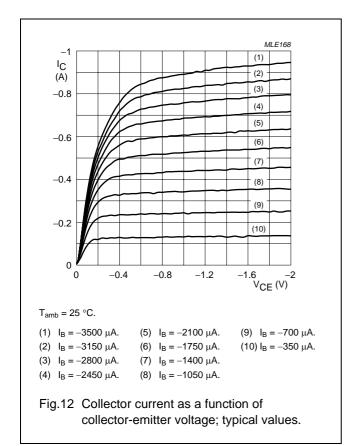
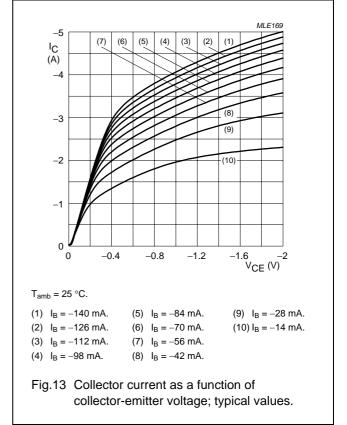


Fig.11 Equivalent on-resistance as a function of collector current; typical values.





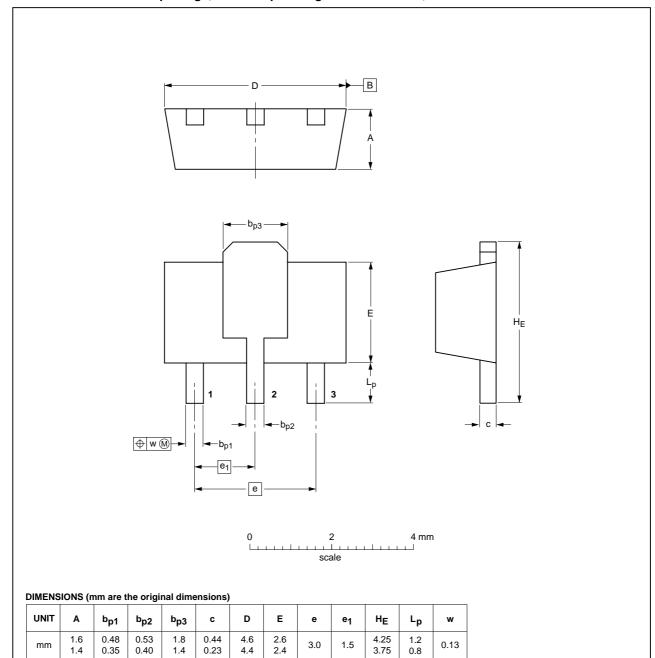
50 V, 3 A PNP low  $V_{CEsat}$  (BISS) transistor

PBSS5350X

#### **PACKAGE OUTLINE**

#### Plastic surface-mounted package; collector pad for good heat transfer; 3 leads

SOT89



OUTLINE	OUTLINE REFERENCES		EUROPEAN	ICCUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION ISSUE DATE	
SOT89		TO-243	SC-62			<del>04-08-03</del> 06-03-16
	·					

## 50 V, 3 A PNP low V<sub>CEsat</sub> (BISS) transistor

PBSS5350X

#### **DATA SHEET STATUS**

DOCUMENT STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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